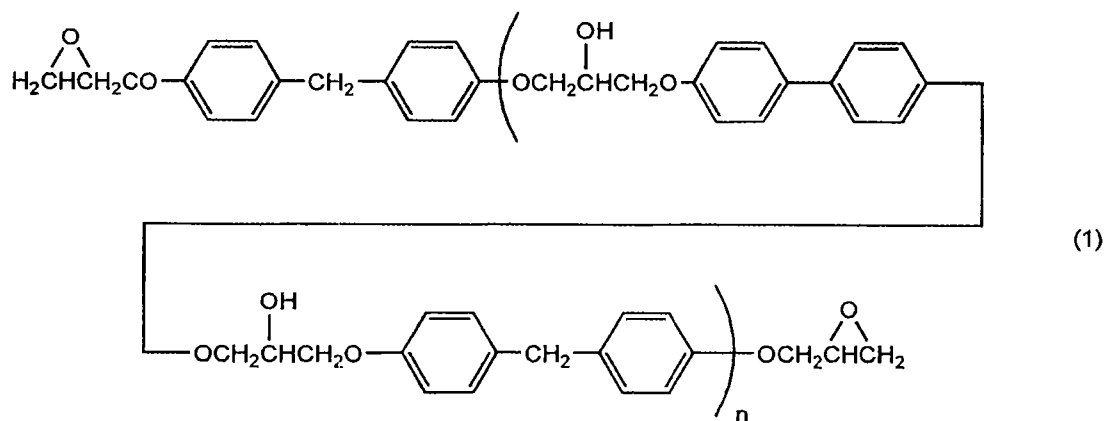


ABSTRACT

An object of the present invention is to provide an epoxy resin that can be easily produced, can easily achieve a molecule-aligned state, and can be cured to provide a cured material with optical anisotropy and excellent toughness and thermal conductivity. The epoxy resin of the present invention is represented by the following formula

(1):

[1]



(wherein n is 0.1 to 20(the number is an average)). The epoxy resin of the present invention can be produced by extending the chain of an epoxide of 4,4'-bisphenol F with 4,4'-biphenol.



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